

UNISONIC TECHNOLOGIES CO., LTD

4N70K **Power MOSFET**

4.4A, 700V N-CHANNEL POWER MOSFET

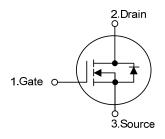
DESCRIPTION

The UTC 4N70K is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche. This high speed switching power MOSFET is usually used in power supplies, PWM motor controls, high efficient DC to DC converters and bridge circuits.

FEATURES

- * $R_{DS(ON)} = 2.8\Omega @V_{GS} = 10 \text{ V}$
- * Ultra Low Gate Charge (Typical 15nC)
- * Low Reverse Transfer Capacitance (C_{RSS} = Typical 8.0 pF)
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness

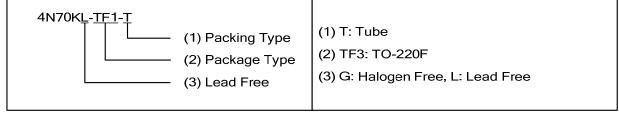
SYMBOL

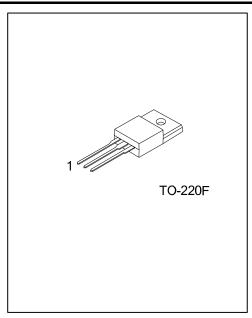


ORDERING INFORMATION

Lead Free Halogen Free 1 2 3		Ordering Number		Dookogo	Pin Assignment			Dealine	
4N70KL-TF3-T 4N70KG-TF3-T TO-220F G D S Tube	Lead Free		Halogen Free	Package	1	2	3	Packing	
		4N70KL-TF3-T	4N70KG-TF3-T	TO-220F	G	D	S	Tube	

Note: Pin Assignment: G: Gate S: Source D: Drain





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■ **ABSOLUTE MAXIMUM RATINGS** (T_A = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	700	V
Gate-Source Voltage		V_{GSS}	±30	V
Avalanche Current (No	ote 2)	I _{AR}	4.4	Α
Dania Oceana	Continuous	^D	4.4	Α
Drain Current Pulsed (Note 2)		I_{DM}	17.6	Α
Single Pulsed (Note 3)		E _{AS}	120	mJ
Avalanche Energy Repetitive (Note 2)		E_{AR}	10.6	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
Power Dissipation		P_{D}	36	W
Junction Temperature		T٦	+150	°C
Operating Temperature		T_{OPR}	-55 ~ +150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 26.9mH, I_{AS} = 4.4A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}$ C
- 4. $I_{SD} \le 4.4A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	62.5	°C/W
Junction to Case	θ_{Jc}	3.47	°C/W

■ ELECTRICAL CHARACTERISTICS (T_A =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		BV_{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	700			V		
Drain-Source Leakage Current		I _{DSS}	$V_{DS} = 700 \text{ V}, V_{GS} = 0 \text{ V}$			10	μΑ		
Cata Sauraa Laakaga Current	Forward	. \	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA		
Gate-Source Leakage Current Reverse		I _{GSS} ,	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	IIA		
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS} \! / \triangle T_J$	I _D = 250μA, Referenced to 25°C		0.6		V/°C		
ON CHARACTERISTICS									
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V		
Static Drain-Source On-State Resistance		R _{DS(ON)}	$V_{GS} = 10 \text{ V}, I_D = 2.2 \text{ A}$		2.6	2.8	Ω		
DYNAMIC CHARACTERISTICS									
Input Capacitance		C_{ISS}	V - 25 V V - 0 V		520	670	pF		
Output Capacitance		Coss	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1 \text{MHz}$		70	90	pF		
Reverse Transfer Capacitance		C _{RSS}] = VIMZ		8	11	рF		

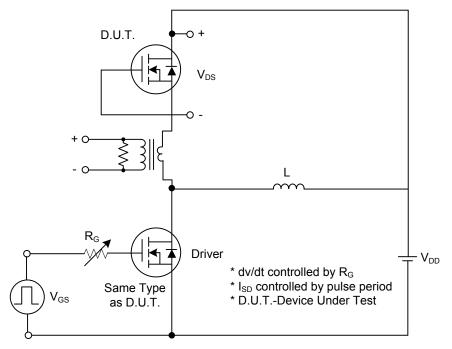
■ ELECTRICAL CHARACTERISTICS(Cont.)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
SWITCHING CHARACTERISTICS								
Turn-On Delay Time	t _{D(ON)}			13	35	ns		
Turn-On Rise Time	t_R	$V_{DD} = 350V, I_D = 4.4A,$		45	100	ns		
Turn-Off Delay Time	t _{D(OFF)}	$R_G = 25\Omega$ (Note 1, 2)		25	60	ns		
Turn-Off Fall Time	t _F			35	80	ns		
Total Gate Charge	Q_{G}	V 500V I 4.4A		15	20	nC		
Gate-Source Charge	Q_GS	V _{DS} = 560V, I _D = 4.4A, V _{GS} = 10 V (Note 1, 2)		3.4		nC		
Gate-Drain Charge	Q_GD	VGS- 10 V (Note 1, 2)		7.1		nC		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS} = 0 \text{ V}, I_{S} = 4.4 \text{ A}$			1.4	V		
Maximum Continuous Drain-Source Diode Forward Current	Is				4.4	Α		
Maximum Pulsed Drain-Source Diode Forward Current	I _{SM}				17.6	Α		
Reverse Recovery Time	t _{rr}	$V_{GS} = 0 \text{ V}, I_{S} = 4.4 \text{ A},$		250		ns		
Reverse Recovery Charge	Q_{RR}	dl/dt = 100 A/µs (Note 1)		1.5		μC		

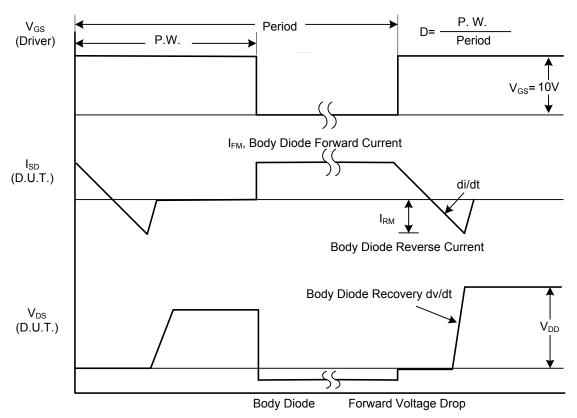
Notes: 1. Pulse Test: Pulse width≤300µs, Duty cycle≤2%

2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

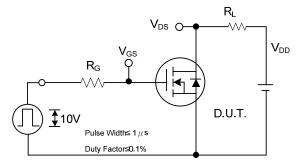


Peak Diode Recovery dv/dt Test Circuit

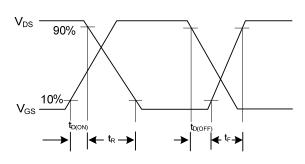


Peak Diode Recovery dv/dt Waveforms

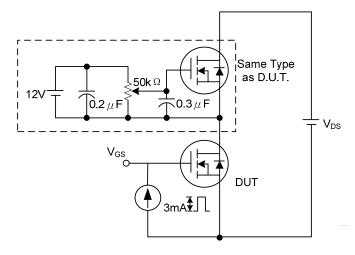
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



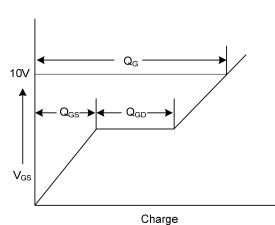
Switching Test Circuit



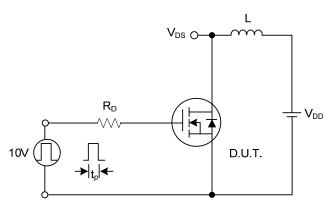
Switching Waveforms



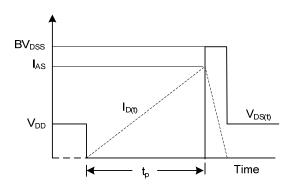
Gate Charge Test Circuit



Gate Charge Waveform

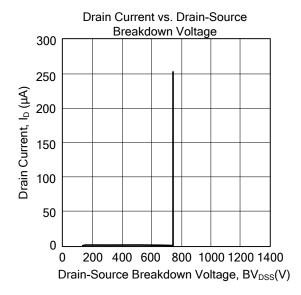


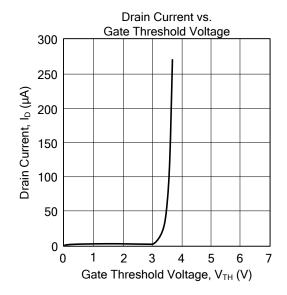
Unclamped Inductive Switching Test Circuit

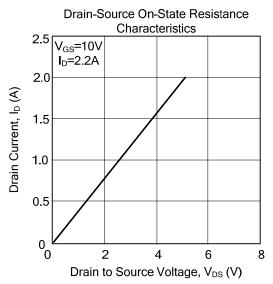


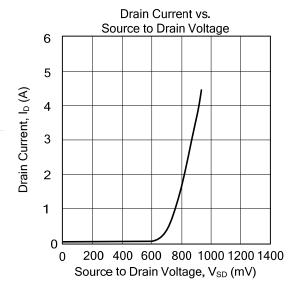
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS









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